

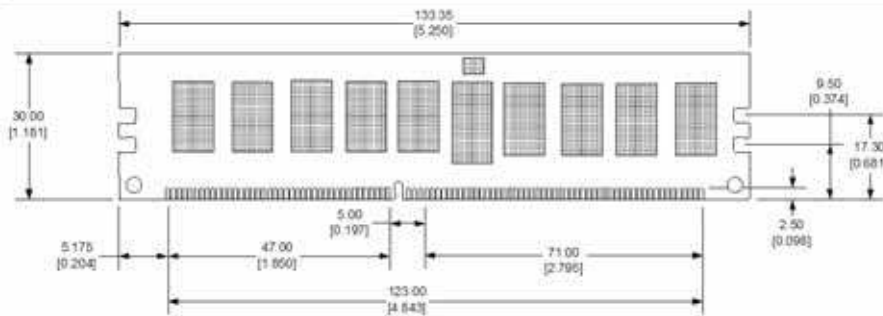
Products in Family

GRSX6270-13/2GB (1 x 2GB 1Rx4 DIMMs)
 GRSX6270-813/2GB (1 x 2GB 2Rx8 DIMMs)
 GRSX6270-13/4GB (1 x 4GB 2Rx4 DIMMs)
 GRSX6270-13/8GB (1 x 8GB 2Rx4 DIMMs)



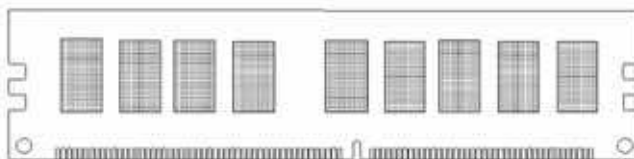
Features	Description
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V \pm 0.075 Fully RoHS Compliant Thermal Sensor	Each GRSX6270-13 upgrade consists of a single DDR3-1333 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-10600 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.

Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRSX6270-13/2GB GRSX6270-813/2GB GRSX6270-13/4GB GRSX6270-13/8GB	X4653A Not Offered by Sun X4654A Not Offered by Sun	Sun Blade X6270 Server Module

Front view

Notes

Tolerances on all dimensions except where otherwise indicated are \pm .13 (.005).

All dimensions are expressed in millimeters [inches]

Back view

Side view
